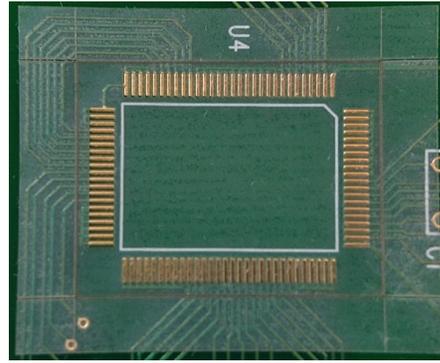
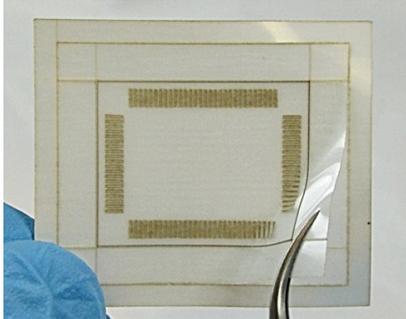


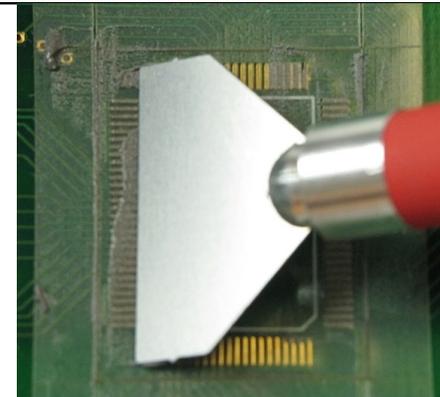
STEP 1 Examine the stencil to make sure that it fits the land patterns on the PCB. Make sure site is wicked (if reworked) and cleaned.



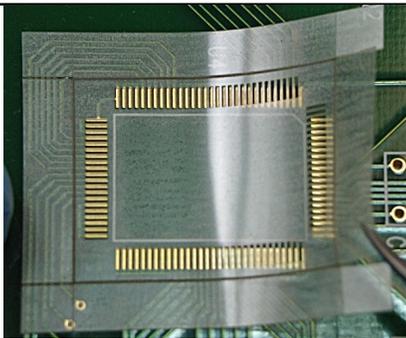
STEP 6 Once aligned and place insure that the hole patterns in the stencil align with the land patterns on the board. Make the board or solder "fence around the pattern by folding up the sides.



STEP 2 From the corner work the stencil off the backing material.



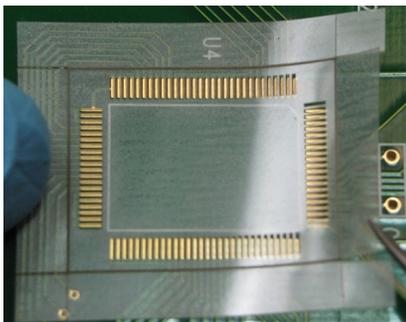
STEP 6 Roll solder paste through the apertures. You can squeegee the paste as many times as you want. Do not press too firmly else the stencil may shift on you.



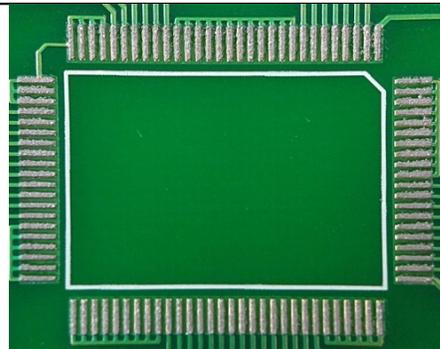
STEP 3 Once the stencil has been peeled off the release liner begin aligning at a corner of the pattern and "work" the alignment slowly in X and Y over the land patterns.



STEP 7 Pull off the stencil carefully making sure no solder paste is accidentally smeared on neighboring areas of the board/parts. Discard stencil.



STEP 4 Finish aligning and placing the stencil.



STEP 8 Inspect solder paste. You are now ready to place the part.



OPTIONAL

In some cases there may be a "fence" constructed around the periphery of the stencil pattern. Fold the sides up and secure in the corners as shown.

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StikNPeel Instructions 3-2010

